



A Product Line of Diodes Incorporated



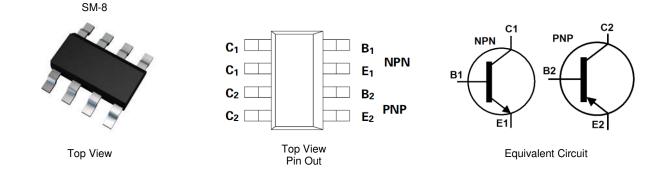
100V COMPLEMENTARY MEDIUM POWER TRANSISTOR IN SM-8

Features

- NPN Transistor
 - BV_{CEO} > 100
 - I_C = 2A High Continuous Current
 - Low Saturation Voltage V_{CE(sat)} < 300mV @ 1A
- PNP Transistor
 - BV_{CEO} > -100V
 - I_C = -2A High Continuous Current
 - Low Saturation Voltage V_{CE(sat)} < -300mV @ -1A
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SM-8 (8 LEAD SOT223)
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 (@3)
- Weight: 0.117 grams (Approximate)



Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZDT6753TA	T6753	7	12	1,000
ZDT6753TC	T6753	13	12	4,000

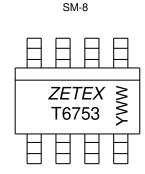
Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



T6753 = Product Type Marking Code YWW = Date Code Marking Y or \overline{Y} = Last Digit of Year (ex: 5= 2015) WW or $\overline{W}W$ = Week Code (01~53)





Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	NPN	PNP	Unit
Collector-Base Voltage	V _{CBO}	120	-120	V
Collector-Emitter Voltage	V _{CEO}	100	-100	V
Emitter-Base Voltage	V _{EBO}	7	-7	V
Continuous Collector Current	Ι _C	2	-2	A
Peak Pulse Current (Note 5)	I _{CM}	6	-6	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Collector Power Dissipation	(Note 5)	р	2.25	w	
Collector Power Dissipation	(Note 6)	P _D	2.75	vv	
Thermal Desistance Junction to Ambient	(Note 5)	D	55.6	°C/W	
Thermal Resistance, Junction to Ambient	(Note 6)	R _{θJA}	45.5	- C/W	
Thermal Resistance, Junction to Leads (Note 7)		R _{θJL}	30.7	°C/W	
Operating and Storage Temperature Range		T _J ,T _{STG}	-55 to +150	°C	

ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

5. For a device with any single die active and mounted with the collector lead on 25mm x 25mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state. Notes:

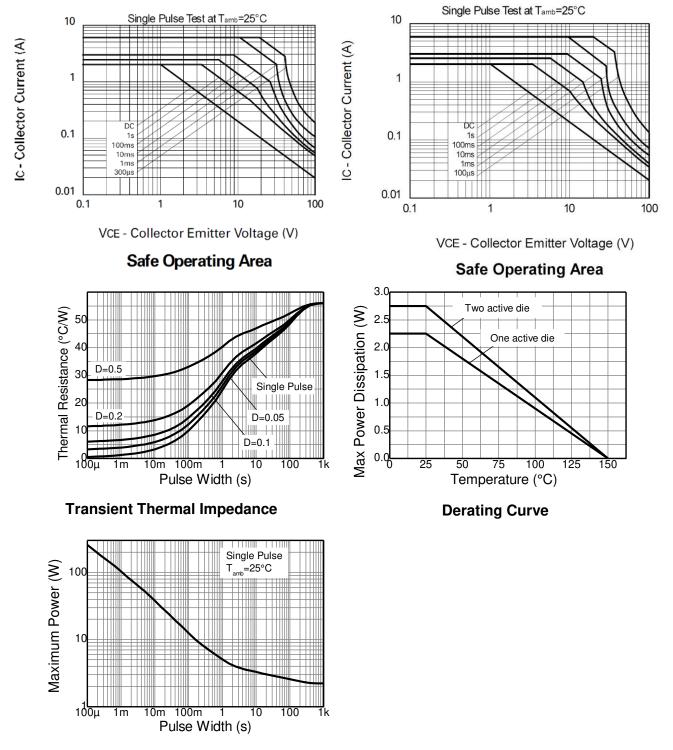
6. Same as Note 5, except both die are active and equally sharing power.

Thermal resistance from junction to solder point (at the end of the collector lead).
Refer to JEDEC specification JESD22-A114 and JESD22-A115.





Thermal Characteristics and Derating Information



Pulse Power Dissipation





NPN - Electrical Characteristic		⁵ C, unless of		neu.)		
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	120	—	—	V	$I_C = 100 \mu A$
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	100	-	—	V	I _C = 10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	7	—	—	V	I _E = 100μA
Collector Cut-Off Current	1	_	< 1	0.1	μΑ	V _{CB} = 100V
	I _{CBO}		—	10	μΑ	$V_{CB} = 100V, T_A = +125^{\circ}C$
Emitter Cut-Off Current	I _{EBO}		< 1	0.1	μΑ	$V_{EB} = 5.6V$
	h _{FE}	70	200	—	_	$I_C = 50 \text{mA}, V_{CE} = 2 \text{V}$
DC Current Transfer Static Ratio (Note 9)		100	200	300		$I_{C} = 500 \text{mA}, V_{CE} = 2 \text{V}$
DC Current Transfer Static Ratio (Note 9)		55	110	_		$I_C = 1A, V_{CE} = 2V$
		25	55	_		$I_C = 2A, V_{CE} = 2V$
Collector Emitter Seturation Voltage (Nate 0)	V _{CE(sat)}	_	0.13	0.30	v	$I_{C} = 1A, I_{B} = 100mA$
Collector-Emitter Saturation Voltage (Note 9)		_	0.23	0.50		$I_{C} = 2A, I_{B} = 200mA$
Base-Emitter Saturation Voltage (Note 9)	V _{BE(sat)}	_	0.9	1.25	V	$I_{C} = 1A, I_{B} = 100mA$
Base-Emitter Turn-on Voltage (Note 9)	V _{BE(on)}	_	0.8	1.0	V	$I_C = 1A, V_{CE} = 2V$
Transitional Frequency	fT	140	175	—	MHz	$I_C = 100 \text{mA}, V_{CE} = 5 \text{V},$ f = 100MHz
Output Capacitance	C _{obo}	_	_	30	pF	V _{CB} = 10V, f = 1MHz
	t _{on}	_	80	_	Ns	$V_{CC} = 10V, I_C = 500mA,$
Switching Time	t _{off}	_	1200	_	ns	$I_{B1} = -I_{B2} = 50 \text{mA}$

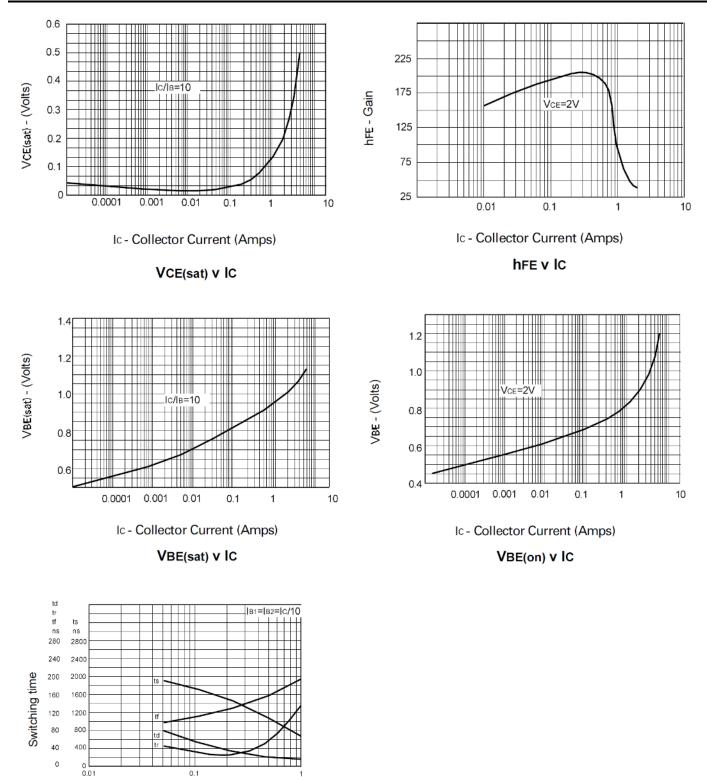
NPN - Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Note: 9. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.





NPN – Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)



Ic - Collector Current (Amps)

Switching Speeds



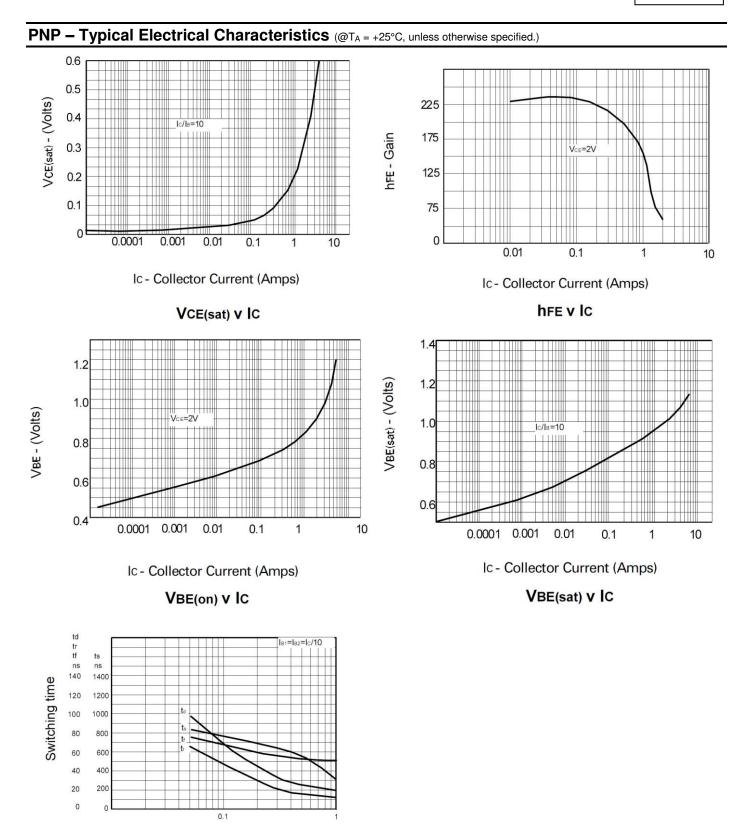


PNP - Electrical Characteristics (@T_A = +25°C, unless otherwise specified.) **Test Condition** Characteristic Min Unit Symbol Тур Max -120 ٧ Collector-Base Breakdown Voltage $\mathsf{BV}_{\mathsf{CBO}}$ $I_{C} = -100 \mu A$ Collector-Emitter Breakdown Voltage (Note 9) -100 ___ ٧ _ $I_C = -10mA$ **BV**CEO Emitter-Base Breakdown Voltage -7 ۷ $I_{E} = -100 \mu A$ **BV**_{EBO} ____ _____ V_{CB} = -100V _ -0.1 μΑ < 1 Collector Cut-Off Current I_{CBO} -10 $V_{CB} = -100V, T_A = +125^{\circ}C$ μΑ _ ____ Emitter Cut-Off Current -0.1 < 1 μΑ $V_{EB} = -5.6V$ **I**EBO _ 70 200 $I_{C} = -50mA$, $V_{CE} = -2V$ 200 300 100 $I_{C} = -500 \text{mA}, V_{CE} = -2V$ DC Current Transfer Static Ratio (Note 8) h_{FE} 55 170 $I_C=-1A,\,V_{CE}=-2V$ — $I_C=-2A,\,V_{CE}=-2V$ 25 55 _ -0.17 -0.30 $I_{C} = -1A, I_{B} = -100mA$ Collector-Emitter Saturation Voltage (Note 9) ٧ V_{CE(sat)} -0.30 -0.50 $I_{C} = -2A, I_{B} = -200mA$ Base-Emitter Saturation Voltage (Note 9) V_{BE(sat)} -0.90 -1.25 V $I_{C} = -1A, I_{B} = -100mA$ _ Base-Emitter Turn-On Voltage (Note 9) ٧ -0.80 -1.0 $I_{C} = -1A, V_{CE} = -2V$ V_{BE(on)} ____ $I_{C} = -100 \text{mA}, V_{CE} = -5 \text{V},$ Transitional Frequency f_T 100 140 MHz ____ f = 100MHzOutput Capacitance Cobo 30 pF V_{CB} = -10V, f = 1MHz, ____ 35 t_{on} ns $V_{CC} = -10V, I_{C} = -500mA,$ Switching Time 600 $I_{B1} = -I_{B2} = -50mA$ ns t_{off}

Note: 9. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.







Ic - Collector Current (Amps)

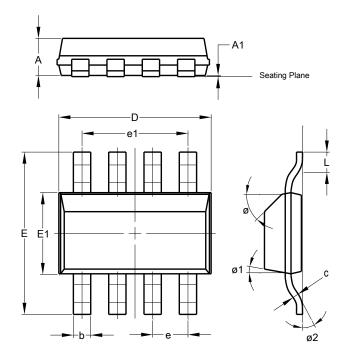
Switching Speeds





Package Outline Dimensions

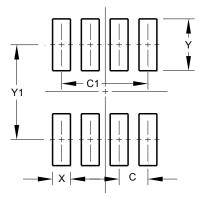
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	SM-8				
Dim	Min Max Typ				
Α		1.70	1.60		
A1	0.02	0.10	0.04		
b	0.70	0.90	0.80		
c	0.24	0.32	0.28		
D	6.30	6.70	6.60		
e	1.53 REF				
e1		4.59 RE	F		
Е	6.70	7.30	7.00		
E1	3.30	3.70	3.50		
L	0.75	1.00	0.90		
Ø	45°				
Ø1		15°			
Ø2			10°		
All I	All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.52
C1	4.6
Х	0.95
Y	2.80
Y1	6.80

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.





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